

### Product Summary

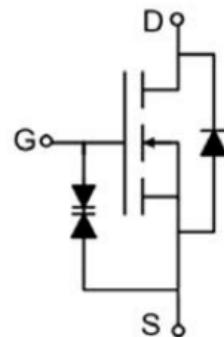
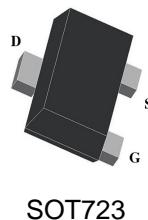
- \*  $R_{DS(on)}$ =Typ 200m $\Omega$ @ $V_{GS}$ = 4.5V
- \*  $R_{DS(on)}$ =Typ 250m $\Omega$ @ $V_{GS}$ = 2.5V
- \* Lead free product is acquired
- \* Surface mount package
- \* N-channel switch with low  $R_{DS(on)}$
- \* Operated at low logic level gate drive
- \* ESD protection

### Application

- \* Load/Power switch
- \* Interfacing, logic switching
- \* Battery management for ultra portable electronics

### Package and Pin Configuration

Circuit diagram



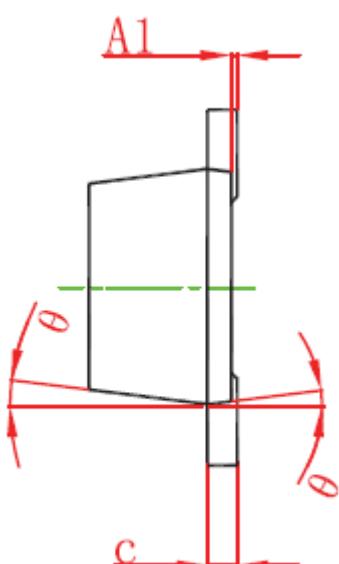
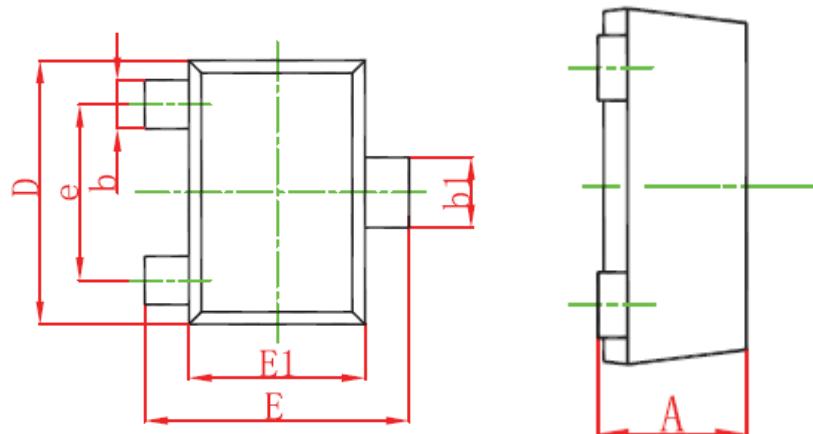
### Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	20	V
Gate-Source Voltage	$V_{GS}$	$\pm 8$	V
Continuous Drain Current @ $25^\circ\text{C}$ (note 1)	$I_D$	0.95	A
Pulsed Drain Current @ $25^\circ\text{C}$ ( $t_p=10 \mu\text{s}$ )	$I_{DM}$	1.5	A
Diode Continuous Forward Current	$I_S$	0.5	A
Power Dissipation @ $25^\circ\text{C}$ (note 1)	$P_D$	150	mW
Thermal Resistance from Junction to Ambient (note 1)	$R_{\theta JA}$	820	$^\circ\text{C}/\text{W}$
Maximum Junction Temperature	$T_J$	150	$^\circ\text{C}$
Storage Temperature	$T_{STG}$	-55 ~ +150	$^\circ\text{C}$

**Electrical Characteristics (  $T_A = 25^\circ\text{C}$  unless otherwise noted )**

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>Static Characteristics</b>						
Drain-source Breakdown Voltage	$V_{(\text{BR})DS}$	$V_{GS} = 0V, I_D = 250\mu\text{A}$	20			V
Drain-to-Source Leakage Current	$I_{DS}$	$V_{DS} = 16V, V_{GS} = 0V$			1	$\mu\text{A}$
Gate-Body Leakage Current	$I_{GS}$	$V_{GS} = \pm 8V, V_{DS} = 0V$			$\pm 10$	$\mu\text{A}$
Gate Threshold Voltage (note 2)	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	0.45	0.65	1	V
Static Drain-Source On-Resistance (note 2)	$R_{DS(\text{on})}$	$V_{GS} = 4.5V, I_D = 0.55A$		200	350	$\text{m}\Omega$
		$V_{GS} = 2.5V, I_D = 0.50A$		250	420	$\text{m}\Omega$
		$V_{GS} = 1.8V, I_D = 0.35A$		310	480	$\text{m}\Omega$
Body-diode forward voltage	$V_{SD}$	$I_S = 0.35A, V_{GS} = 0V$		0.9	1.5	V
<b>Dynamic Characteristics (note 4)</b>						
Total Gate Charge	$Q_g$	$V_{DS} = 10V$ $I_D = 0.55A$ $V_{GS} = 4.5V$		1.15		nC
Gate-Source Charge	$Q_{gs}$			0.15		nC
Gate-Drain Charge	$Q_{gd}$			0.23		nC
Input capacitance	$C_{iss}$	$V_{DS} = 10V$ $V_{GS} = 0V$ $f = 100\text{KHz}$		50		pF
Output capacitance	$C_{oss}$			13		pF
Reverse transfer capacitance	$C_{rss}$			8		pF
Turn-on delay time (note 3)	$t_{d(on)}$	$V_{GS} = 4.5V$ $V_{DS} = 10V$ $I_D = 0.55A$ $R_{GEN} = 6\Omega$		22		nS
Turn-on rise time (note 3)	$t_r$			80		nS
Turn-off delay time (note 3)	$t_{d(off)}$			700		nS
Turn-off fall time (note 3)	$t_f$			380		nS

SOT723 - Package Outline Drawing



Symbol	DIMENSIONS			
	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	0.43	0.50	0.017	0.020
A1	0.00	0.05	0.000	0.002
b	0.17	0.27	0.007	0.011
b1	0.27	0.37	0.011	0.015
c	0.08	0.15	0.003	0.006
D	1.15	1.25	0.045	0.049
E	1.15	1.25	0.045	0.049
E1	0.75	0.85	0.03	0.033
e	0.8 typ		0.031 typ	
$\theta$	7° REF		7° REF	

Suggested Land Pattern

